<u>onsemi</u>

MOSFET – Power, N-Channel, SUPERFET[®] III, Easy-Drive

650 V, 80 mΩ, 38 A

FCMT080N65S3

General Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

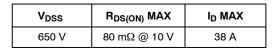
The Power88 package is an ultra-slim surface-mount package (1 mm high) with a low profile and small footprint (8x8 mm²). SUPERFET III MOSFET in a Power88 package offers excellent switching performance due to lower parasitic source inductance and separated power and drive sources. Power88 offers Moisture Sensitivity Level 1 (MSL 1).

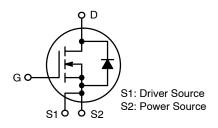
Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ $R_{DS(on)} = 70 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 71 \text{ nC}$)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 570 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

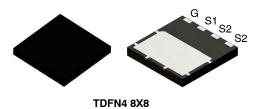
Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



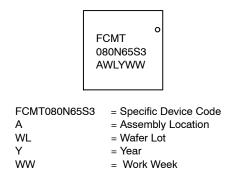


POWER MOSFET



CASE 520AB

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
Ι _D	Drain Current	Continuous (T _C = 25°C)	38	А
		Continuous (T _C = 100°C)	24	
I _{DM}	Drain Current	Pulsed (Note 1)	95	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		180	mJ
I _{AS}	Avalanche Current (Note 2)		4.6	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.6	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P _D	Power Dissipation	(T _C = 25°C)	260	W
		Derate Above 25°C	2.08	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 4.6 \text{ A}$, $R_G = 25 \Omega$ starting $T_J = 25^{\circ}C$ 3. $I_{SD} \le 19 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}C$

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.48	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	45		

4. Device on 1 in² pad 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

ORDERING INFORMATION

Device	Marking	Package	Reel Size	Tape Width	Quantity [†]
FCMT080N65S3	FCMT080N65S3	TDFN4	13″	13.3 mm	3000 Units

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



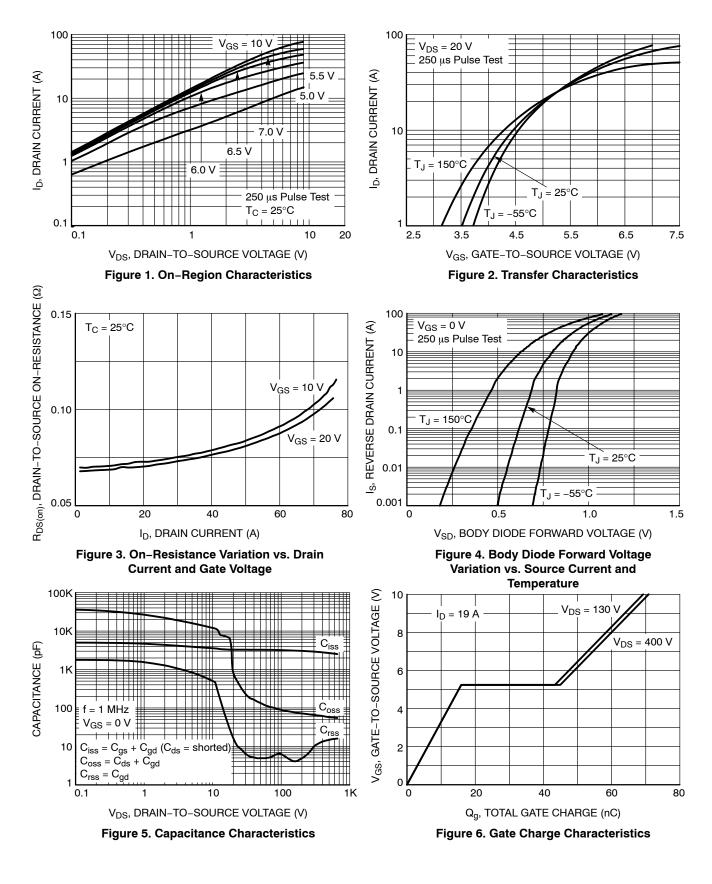
ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 1 mA, Referenced to 25°C	-	0.63	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 650 V, V_{GS} = 0 V	-	-	10	μA
		V_{DS} = 520 V, T_C = 125°C	-	3.0	-	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
N CHARACTE	ERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 0.88$ mA	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 19 A	-	70	80	mΩ
9fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 19 \text{ A}$	-	21	-	S
YNAMIC CHA	RACTERISTICS		•		•	
C _{iss}	Input Capacitance		-	2765	-	pF
Coss	Output Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	65	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	570	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	94	-	pF
Q _{g(tot)}	Total Gate Charge at 10V		-	71	-	nC
Q _{gs}	Gate to Source Gate Charge	V_{DS} = 400 V, I _D = 19 A, V _{GS} = 10 V (Note 5)	-	16	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	29	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.55	-	Ω
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$\begin{array}{l} V_{DD} = 400 \; V, I_{D} = 19 \; A, \\ V_{GS} = 10 \; V, R_{g} = 4.7 \; \Omega \\ (Note \; 5) \end{array}$	-	24	-	ns
t _r	Turn-On Rise Time		-	28	-	ns
t _{d(off)}	Turn-Off Delay Time		-	71	-	ns
t _f	Turn-Off Fall Time		-	5.4	-	ns
OURCE-DRAI	N DIODE CHARACTERISTICS		•		•	
۱ _S	Maximum Continuous Source to Drain Diode Forward Current		-	-	38	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		-	-	95	Α
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I _{SD} = 19 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{DD} = 400 V, I _{SD} = 19 A, dI _F /dt = 100 A/μs	-	405	-	ns
Q _{rr}	Reverse Recovery Charge		-	7.7	-	μC

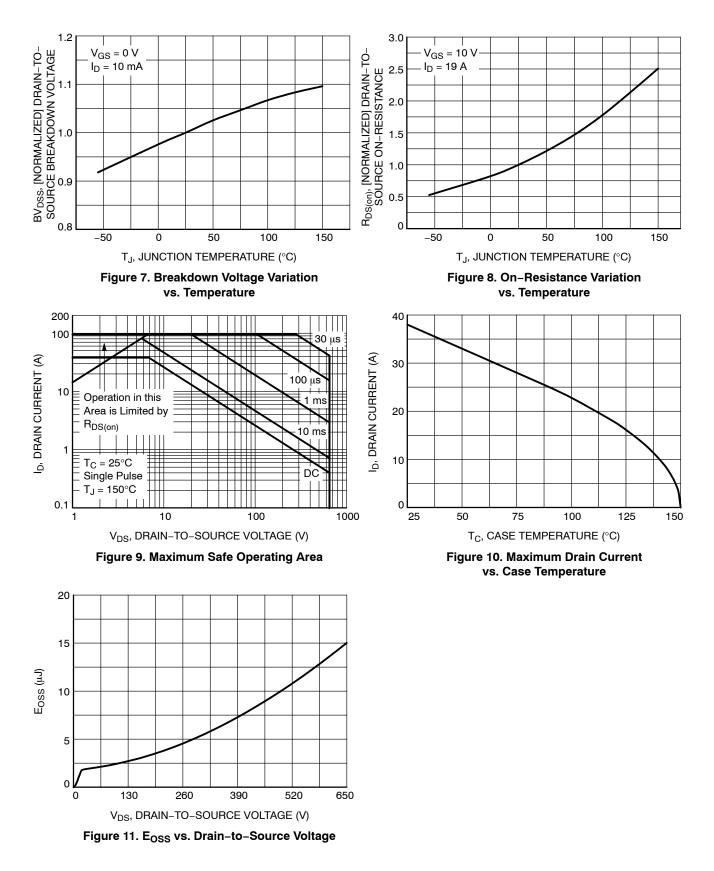
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. Essentially independent of operating temperature typical characteristics.



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





TYPICAL CHARACTERISTICS

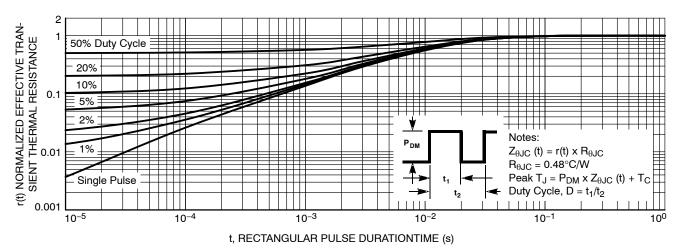


Figure 12. Transient Thermal Response Curve



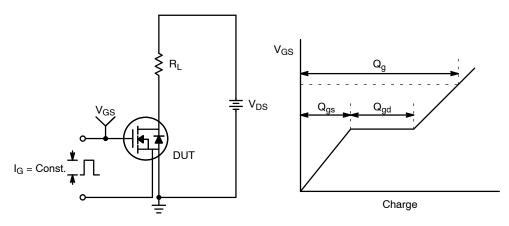


Figure 13. Gate Charge Test Circuit & Waveform

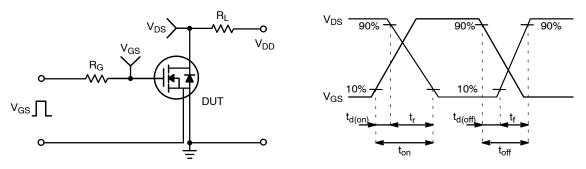
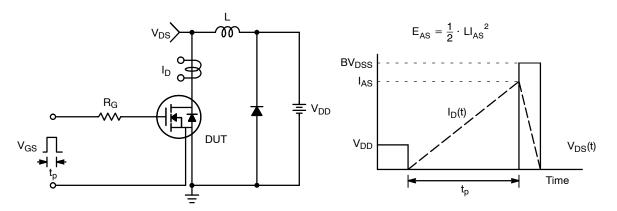


Figure 14. Resistive Switching Test Circuit & Waveforms







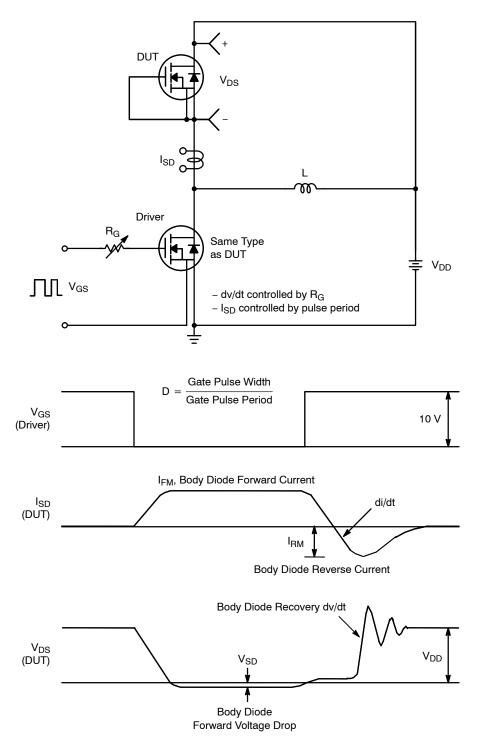
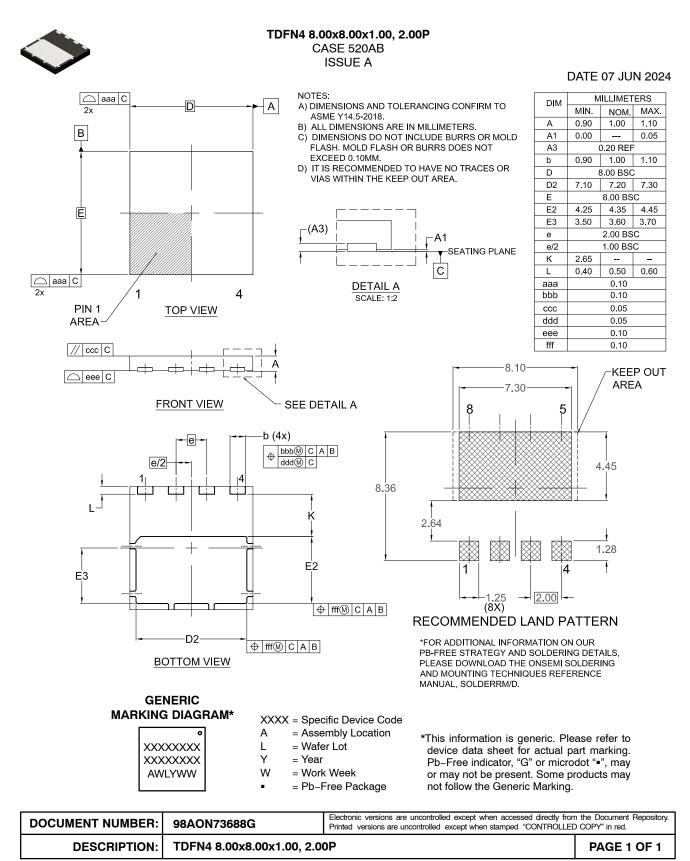


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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